IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants:

Masaru SHIRAI et al.

Confirmation No. 1550

Serial No.:

10/598,142

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August 18, 2006

Examiner:

Nicholas P D'ANIELLO

For:

HEATER, REFLOW APPARATUS, AND SOLDER BUMP FORMING METHOD

AND APPARATUS

United States Patent and Trademark Office Customer Service Window, Mail Stop <u>Amendment</u> Randolph Building 401 Dulany Street Alexandria, VA 22314

REQUEST FOR EXTENSION OF TIME

Sir:

Please extend the time for response to the Official Action dated October 13, 2009 by one month from January 13, 2010 to February 16, 2010 (February 13, 2010 being a Saturday and February 15, 2010 being a federal holiday). The amount of \$130.00 is submitted concurrently herewith as payment for the fee.

The U.S. Patent and Trademark Office is hereby authorized to credit any overpayment or charge any additional fee to Deposit Account No.19-0089.

Respectfully submitted,

Masaru SHIRAI et al.

Bruce H. Bernstein

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